SEMiX443KD22p

SEMiX® 3p

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Features

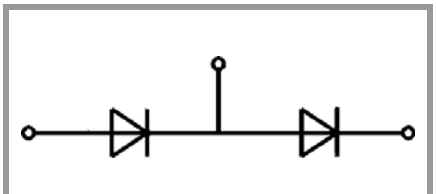
- Rectifier PEP technology for enhanced power and environmental robustness
- T_{jmax} = 150°C
- NTC temperature sensor
- Press-fit pins as auxiliary contacts
- Terminal height 17 mm
- UL recognised file no. E63532

Typical Applications*

- Input Bridge Rectifier for AC/DC motor control
- Power supply

Remarks

- Product reliability results are valid for T_j=150°C
- V_{isol} between temperature sensor and power section is only 2500V
- For storage and case temperature with TIM see document “TP(*) SEMiX 3p”



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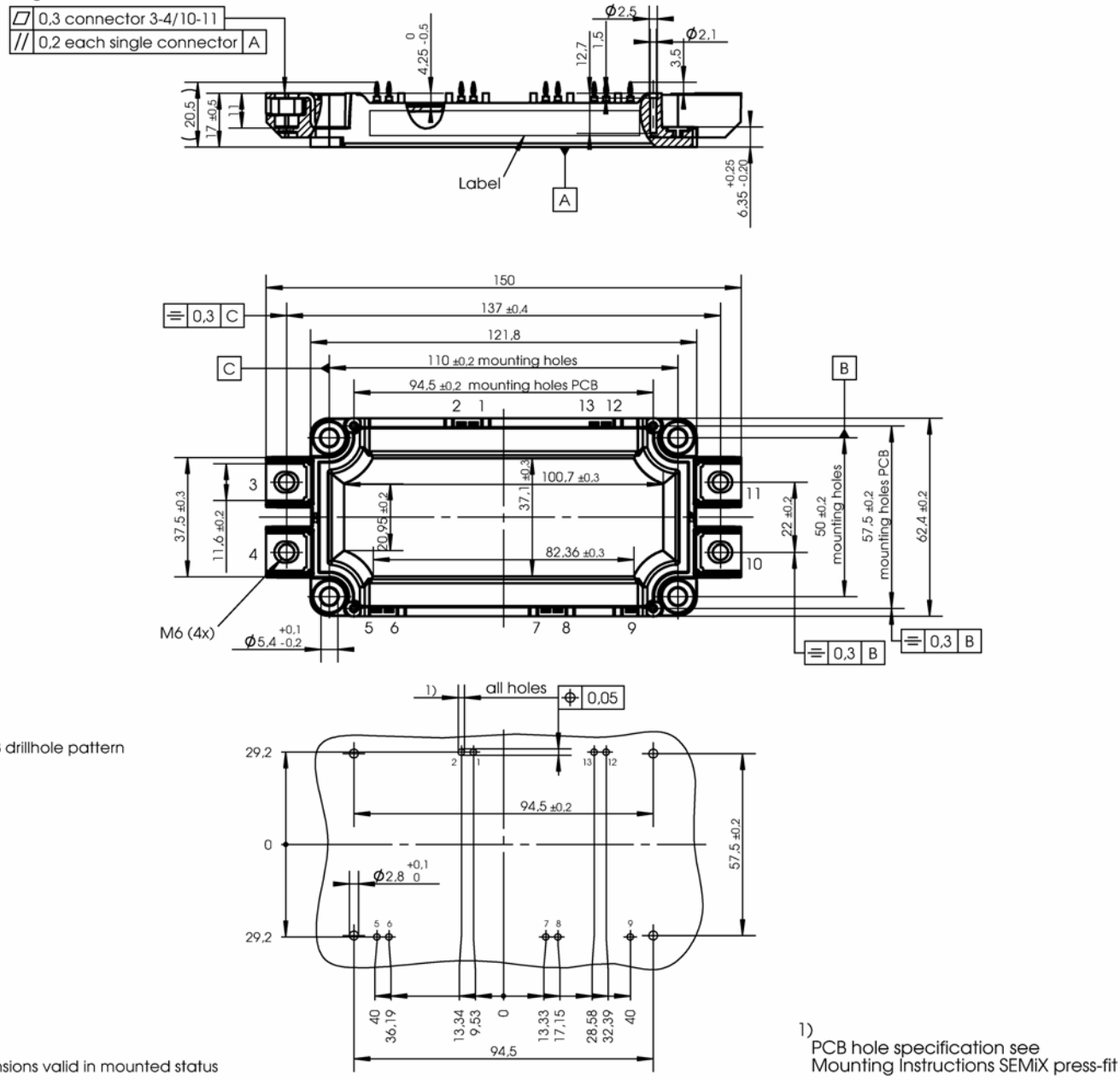
Absolute Maximum Ratings				
Symbol	**Conditions**		**Values**	**Unit**
Recitifier Diode				
I_{FAV}	T_j = 150 °C sin. 180	T_c = 85 °C	580	A
		T_c = 100 °C	476	A
I_{FSM}	10 ms	T_j = 25 °C	10000	A
		T_j = 150 °C	8200	A
i^2t	10 ms	T_j = 25 °C	500000	A^2s
		T_j = 150 °C	336200	A^2s
V_{RSM}			2300	V
V_{RRM}			2200	V
T_j			-40 ... 150	°C
Module				
T_{stg}			-40 ... 125	°C
V_{isol}	AC sinus 50Hz	1 min	4000	V
		1 s	4800	V

Characteristics						
Symbol	**Conditions**		**min.**	**typ.**	**max.**	**Unit**
Diode						
V_F	I_F = 1812 A chiplevel	T_j = 25 °C		1.20	1.37	V
		T_j = 125 °C		1.17	1.36	V
$V_{(TO)}$		T_j = 25 °C		0.90	0.97	V
		T_j = 125 °C		0.78	0.83	V
r_T	chiplevel	T_j = 25 °C		0.17	0.22	mΩ
		T_j = 125 °C		0.22	0.29	mΩ
I_{RD}	T_j = 125 °C, V_{RD} = V_{RRM}				4.6	mA
$R_{th(j-c)}$	sin. 180	per diode			0.09	K/W
						K/W
$R_{th(c-s)}$	per Diode, P12 (reference)			0.034		K/W
$R_{th(c-s)}$	per Diode, HP-PCM			0.016		K/W
Module						
$R_{CC'+EE'}$	measured per switch	T_C = 25 °C		0.4		mΩ
		T_C = 125 °C		0.5		mΩ
$Rth_{(c-s)1}$	calculated without thermal coupling			0.017		K/W
$Rth_{(c-s)2}$	including thermal coupling, T_s underneath module, P12 (reference)			0.024		K/W
$Rth_{(c-s)2}$	including thermal coupling, T_s underneath module, HP-PCM			0.012		K/W
M_s	to heat sink (M5)		3		6	Nm
M_t	to terminals (M6)		3		6	Nm
a					5 * 9.81	m/s^2
w					360	g
Temperature Sensor						
R_{100}	T_c=100°C (R_{25}=5 kΩ)			493 ± 5%		Ω
$B_{100/125}$	$R_{(T)}=R_{100}\exp[B_{100/125}(1/T-1/T_{100})]$; T[K];			3550 ±2%		K

Package outline

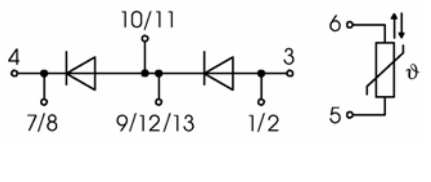


PCB drillhole pattern

Dimensions valid in mounted status

1) PCB hole specification see Mounting Instructions SEMiX press-fit

SEMiX 3p



pinout

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

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